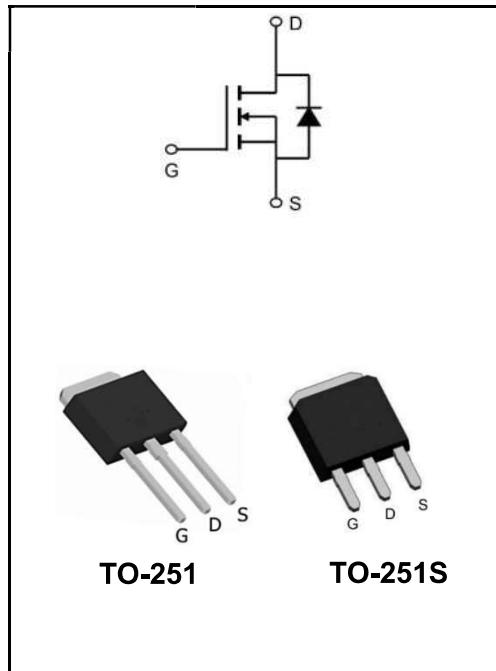


40V N-CHANNEL ENHANCEMENT MODE MOSFET
MAIN CHARACTERISTICS

I_D	150A
V_{DSS}	40V
$R_{DS(on)-typ}(@V_{GS}=10V)$	< 2.5mΩ (Type: 1.9 mΩ)


Application

◆ YFW-SGT technology

Application

◆ Battery protection
◆ Load switch
◆ Uninterruptible power supply

Product Specification Classification

Part Number	Package	Marking	Pack
YFW150N04AMJ	TO-251	YFW 150N04AMJ XXXXX	2500PCS/Tape
YFW150N04AMJ	TO-251S	YFW 150N04AMJ XXXXX	2500PCS/Tape

Maximum Ratings at $T_c=25^\circ\text{C}$ unless otherwise specified

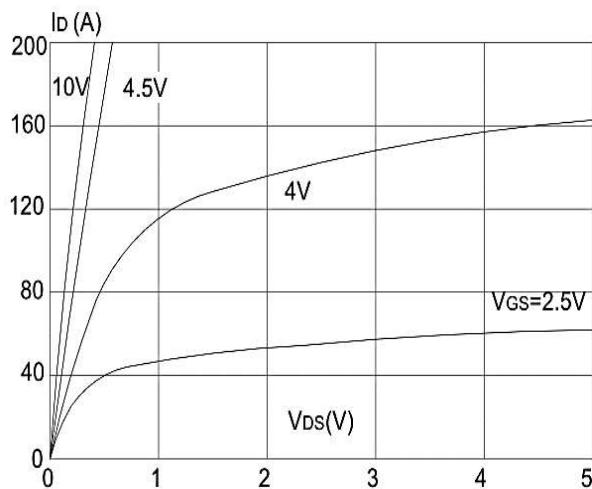
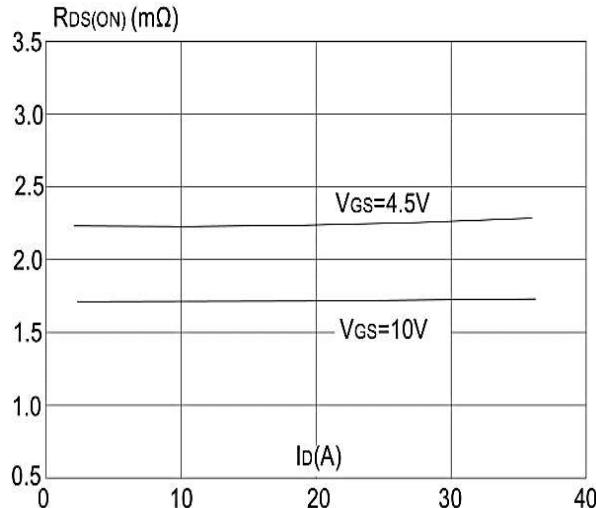
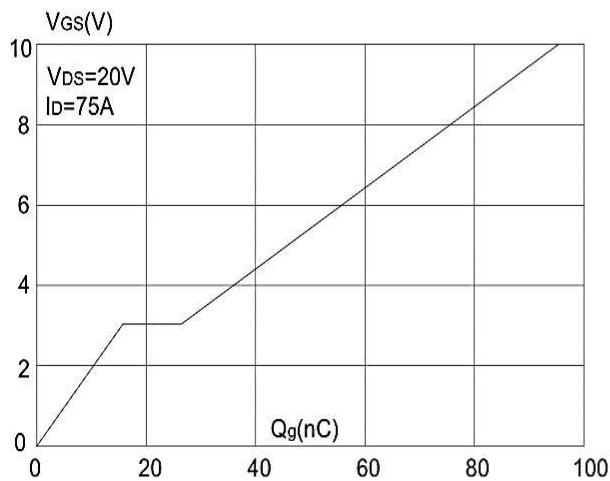
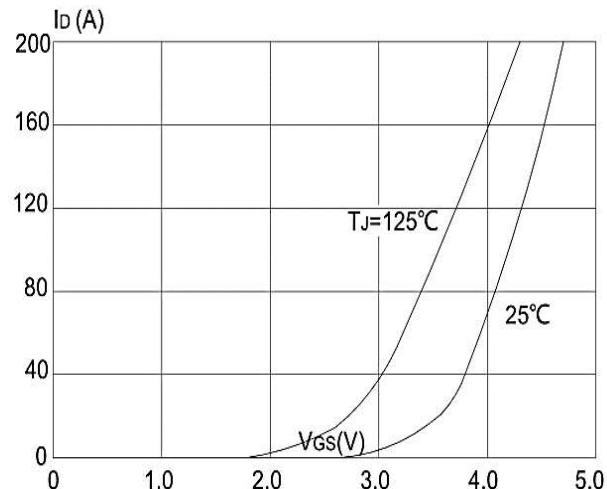
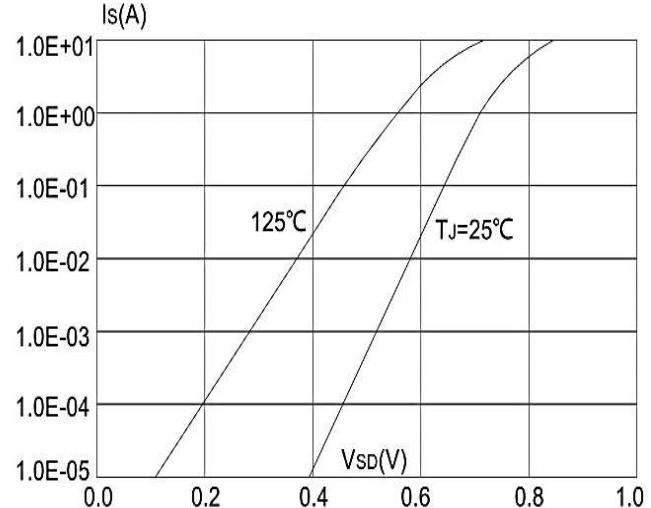
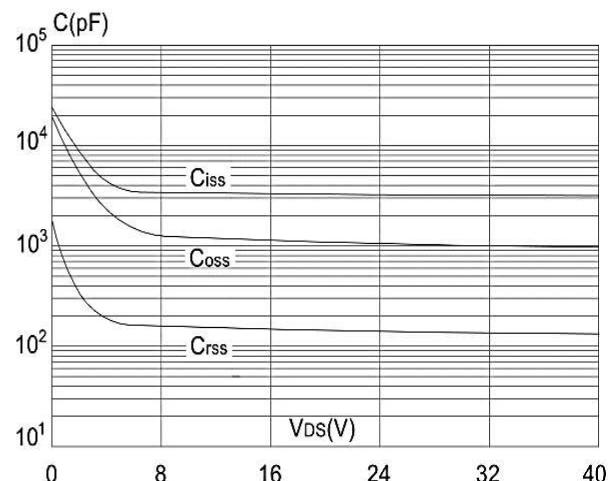
Characteristics	Symbols	Value	Units
Drain-Source Voltage	V_{DS}	40	V
Gate - Source Voltage	V_{GS}	± 20	V
Continuous Drain Current, $V_{GS} @ 10V^{1,6}$ @ $T_c=25^\circ\text{C}$	I_D	150	A
Continuous Drain Current, $V_{GS} @ 10V^{1,6}$ @ $T_c=100^\circ\text{C}$	I_D	90	A
Pulsed Drain Current ²	I_{DM}	450	A
Single Pulse Avalanche Energy ³	E_{AS}	400	mJ
Avalanche Current	I_{AS}	40	A
Total Power Dissipation ⁴ @ $T_c=25^\circ\text{C}$	P_D	125	W
Storage Temperature Range	T_{STG}	-55 to +150	°C
Operating Junction Temperature Range	T_J	-55 to +150	°C
Thermal Resistance Junction-Ambient ¹	$R_{\theta JA}$	50	°C/W
Thermal Resistance Junction-Case ¹	$R_{\theta JC}$	1	°C/W

Maximum Ratings at T_c=25°C unless otherwise specified

Characteristics	Test Condition	Symbols	Min	Typ	Max	Units
Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250uA	BV _{DSS}	40	47	-	V
Static Drain-Source On-Resistance ²	V _{GS} =10V, I _D =20A	R _{DS(ON)}	-	1.9	2.5	mΩ
	V _{GS} =4.5V, I _D =20A		-	3.3	5.0	
Gate -Threshold Voltage	V _{DS} =V _{GS} , I _D =250uA	V _{GS(th)}	1.2	1.6	2.2	V
Drain -Source Leakage Current	V _{DS} =32V , V _{GS} =0V , T _J =25°C	I _{DSS}	-	-	1	μA
	V _{DS} =32V , V _{GS} =0V , T _J =55°C		-	-	5	
Gate-Source Leakage Current	V _{GS} =±20V, V _{DS} =0V	I _{GSS}	-	-	±100	nA
Forward Transconductance	V _{DS} =5V, I _D =20A	g _{FS}	-	53	-	S
Gate Resistance	V _{DS} =0V , V _{GS} =0V , f=1MHz	R _g	-	1.0	-	Ω
Total Gate Charge(4.5V)	V _{DS} =15V V _{GS} =10V I _D =20A	Q _g	-	45	-	nC
Gate-Source Charge		Q _{gs}	-	12	-	
Gate-Drain Charge		Q _{gd}	-	18.5	-	
Turn-on delay time	V _{DD} =15V V _{GS} =10V R _G =3.3Ω I _D =20A	t _{d(on)}	-	18.5	-	ns
Rise Time		T _r	-	9	-	
Turn-Off Delay Time		t _{d(OFF)}	-	58.5	-	
Fall Time		t _f	-	32	-	
Input Capacitance	V _{DS} =20V V _{GS} =0V f=1.0MHz	C _{iss}	-	3972	-	pF
Output Capacitance		C _{oss}	-	1119	-	
Reverse Transfer Capacitance		C _{rss}	-	82	-	
Continuous Source Current ^{1,6}	V _G =V _D =0V , Force Current	I _s	-	-	100	A
Diode Forward Voltage ²	V _{GS} =0V , I _s =1A , T _J =25°C	V _{SD}	-	-	1.2	V

Note :

- 1、The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
- 2、The data tested by pulsed , pulse width ≦ 300us , duty cycle ≦ 2%
- 3、The EAS data shows Max. rating . The test condition is VDD=25V,VGS=10V,L=0.5mH,IAS=40A
- 4、The power dissipation is limited by 150°C junction temperature
- 5、The data is theoretically the same as ID and IDM , in real applications , should be limited by total power dissipation

Ratings and Characteristic Curves
Typical Characteristics

Figure 1: Output Characteristics

Figure 3: On-resistance vs. Drain Current

Figure 5: Gate Charge Characteristics

Figure 2: Typical Transfer Characteristics

Figure 4: Body Diode Characteristics

Figure 6: Capacitance Characteristics

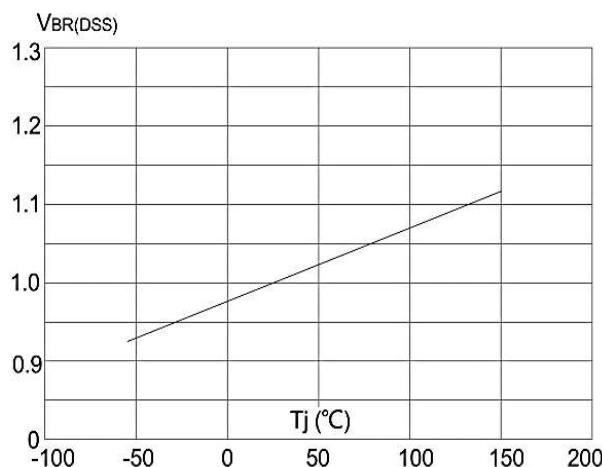
Ratings and Characteristic Curves


Figure 7: Normalized Breakdown Voltage vs. Junction Temperature

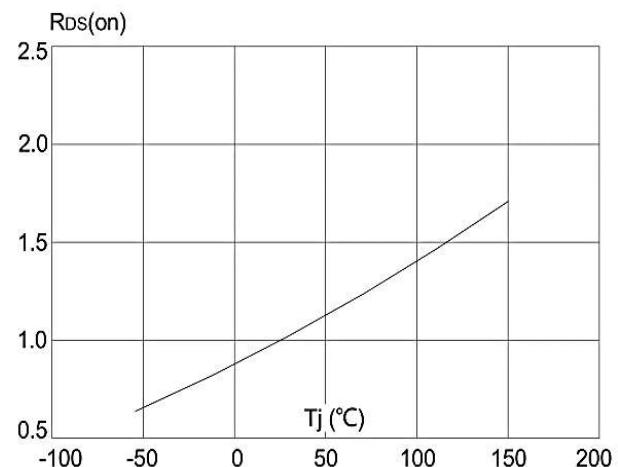


Figure 8: Normalized on Resistance vs. Junction Temperature

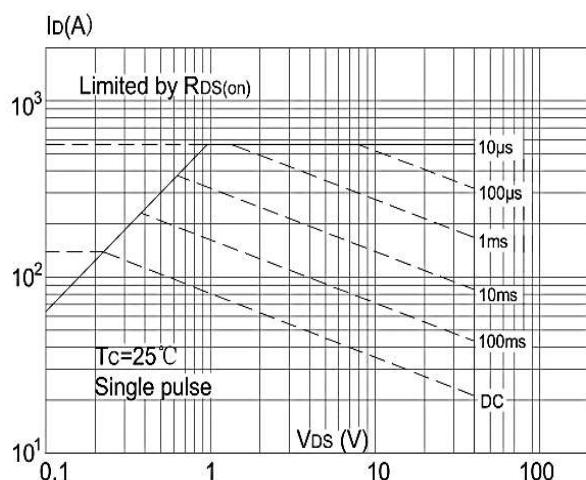


Figure 9: Maximum Safe Operating Area

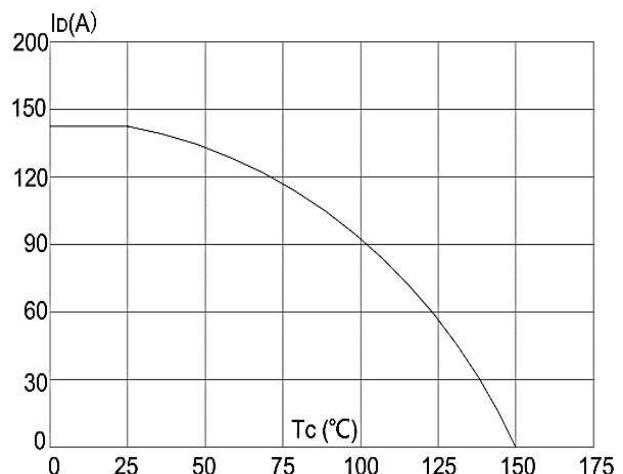


Figure 10: Maximum Continuous Drain Current vs. Case Temperature

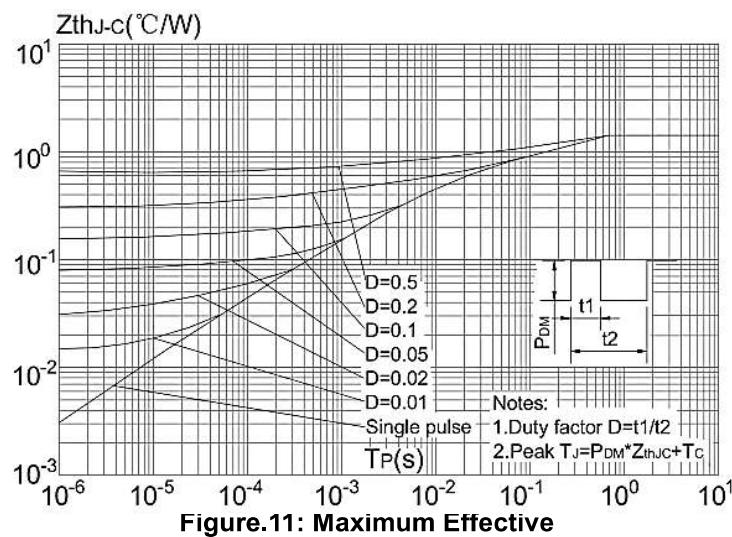
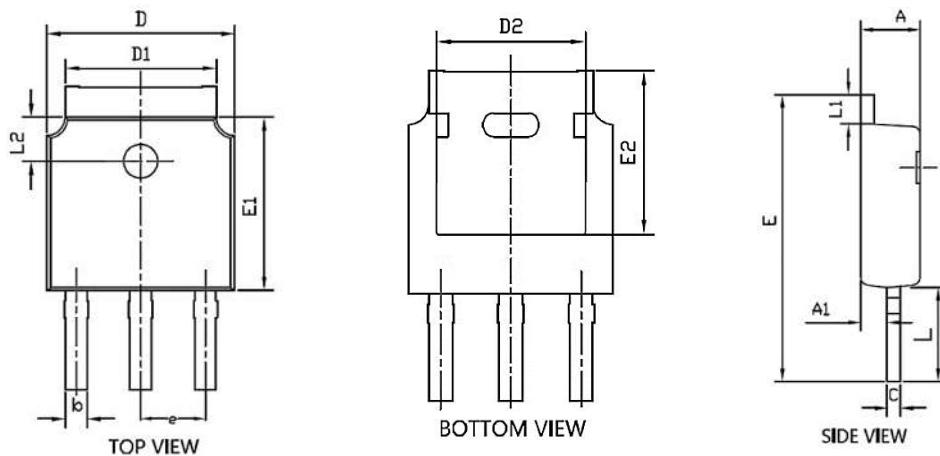


Figure 11: Maximum Effective Transient Thermal Impedance, Junction-to-Cas

Package Outline Dimensions Millimeters

TO-251

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	2.20		2.40	0.088		0.095
A2	0.90		1.20	0.035		0.047
B	0.55		0.65	0.022		0.026
B2	5.10		5.40	0.200		0.213
B3	0.76		0.85	0.030		0.033
C	0.45		0.62	0.018		0.024
C2	0.48		0.62	0.019		0.024
D	6.00		6.20	0.236		0.244
E	6.40		6.70	0.252		0.264
G		2.30			0.091	
H	16.0		17.0	0.630		0.669
L	8.90		9.40	0.350		0.370
L1	1.80		1.90	0.071		0.075
L2	1.37		1.50	0.054		0.059
V1		4°			4°	

Package Outline Dimensions Millimeters
TO-251S


Symbol	Common		
	mm		
	Mim	Nom	Max
A	2.2	2.3	2.4
A1	0.9	1.0	1.1
b	0.66	0.76	0.86
C	0.46	0.52	0.58
D	6.50	6.6	6.7
D1	5.15	5.3	5.45
D2	4.6	4.8	4.95
E	10.4	----	11.5
E1	6.0	6.1	6.2
E2	5.400REF		
e	2.286BSC		
L	3.5	4.0	4.3
L1	0.9	---	1.27
L2	1.4	---	1.9